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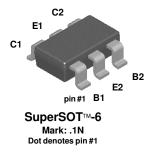
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# FMBA14



# **NPN Multi-Chip Darlington Transistor**

This device is designed for applications requiring extremely high current gain at collector currents to 1.0 A. Sourced from Process 05.

#### Absolute Maximum Ratings\* T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter	Value	Units	
$V_{CES}$	Collector-Emitter Voltage	30	V	
V <sub>CBO</sub>	Collector-Base Voltage	30	V	
V <sub>EBO</sub>	Emitter-Base Voltage	10	V	
I <sub>C</sub>	Collector Current - Continuous	1.2	Α	
T <sub>J</sub> , T <sub>stg</sub>	Operating and Storage Junction Temperature Range	-55 to +150	°C	

<sup>\*</sup>These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

# 

Symbol	Characteristic	Max	Units
		FMBA14	
$P_D$	Total Device Dissipation Derate above 25°C	700 5.6	mW mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	180	°C/W

<sup>1)</sup> These ratings are based on a maximum junction temperature of 150 degrees C.
2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

# **NPN Multi-Chip Darlington Transistor**

(continued)

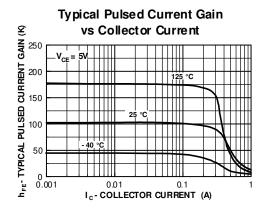
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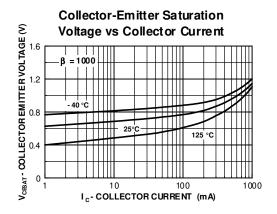
TA = 25°C unless otherwise noted

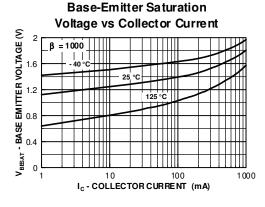
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
OEE CHA	ARACTERISTICS		•			
	Collector-Emitter Breakdown Voltage	I <sub>C</sub> = 100 μA, I <sub>B</sub> = 0	30			V
V <sub>(BR)CES</sub>	ŭ	• •	30		100	
I <sub>CBO</sub>	Collector-Cutoff Current	$V_{CB} = 30 \text{ V}, I_{E} = 0$			100	nA
I <sub>EBO</sub>	Emitter-Cutoff Current	$V_{EB} = 10 \text{ V}, I_{C} = 0$			100	nA
h						
h <sub>FE</sub>	DC Current Gain	$I_C = 10 \text{ mA}, V_{CE} = 5.0 \text{ V}$	10K			
	DC Current Gain  Collector-Emitter Saturation Voltage	$\begin{aligned} I_{C} &= 10 \text{ mA}, \ V_{CE} = 5.0 \ V \\ I_{C} &= 100 \text{ mA}, \ V_{CE} = 5.0 \ V \\ I_{C} &= 100 \text{ mA}, \ I_{B} = 0.1 \text{ mA} \end{aligned}$	10K 20K		1.5	V
V <sub>CE(sat)</sub>		$I_C = 100 \text{ mA}, V_{CE} = 5.0 \text{ V}$	-		1.5	V
V <sub>CE(sat)</sub>	Collector-Emitter Saturation Voltage	I <sub>C</sub> = 100 mA, V <sub>CE</sub> = 5.0 V I <sub>C</sub> = 100 mA, I <sub>B</sub> = 0.1 mA	-		_	

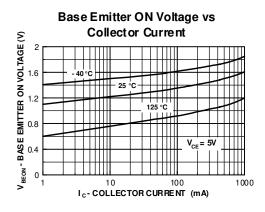
f = 100 MHz

### **Typical Characteristics**









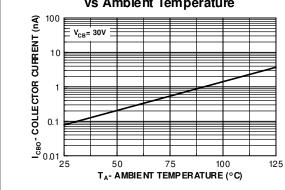
<sup>\*</sup>Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%

# **NPN Multi-Chip Darlington Transistor**

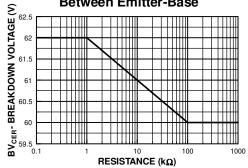
(continued)

### Typical Characteristics (continued)

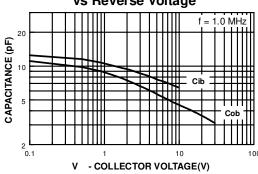
# Collector-Cutoff Current vs Ambient Temperature



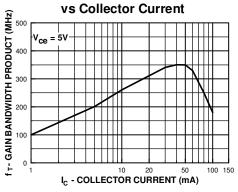
### Collector-Emitter Breakdown Voltage with Resistance Between Emitter-Base



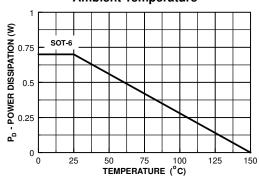
# Input and Output Capacitance vs Reverse Voltage



# Gain Bandwidth Product



### Power Dissipation vs Ambient Temperature



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